

LOCTITE GC 3W

January 2016

PRODUCT DESCRIPTION

LOCTITE GC 3W provides the following product characteristics:

Technology	Solder paste
Application	Pb-free soldering, Halogen-free, Water washable flux

LOCTITE GC 3W is a halogen free, water-washable, Pb-free solder paste specially formulated to provide excellent humidity resistance. LOCTITE GC 3W shows excellent solderability when reflowed in both air and nitrogen across a wide range of challenging surface finishes including OSP-Cu, ENIG and Silver.

FEATURES AND BENEFITS

- Water washable, Pb-free solder paste
- Halogen-free flux: passes IC with pretreatment IPC-TM-650 2.3.34/EN14582
- Halogen-free flux classification: ORM0 to ANSI/J-STD-004 Rev.
- Formulated so residues can be cleaned with deionized water
- Humidity resistance: excellent coalescence after 24 hours exposure to 27°C/80% RH
- Excellent resistance to solder balling, initially and after exposure to humidity
- Suitable for fine pitch, high speed printing up to 150 mms⁻¹ (6"/s)
- Excellent paste transfer efficiency after extended abandon times
- Excellent paste transfer efficiency after extended printing time
- Humidity Resistance: Enhanced tack time
- Suitable for single and double side reflow

TYPICAL PROPERTIES

Solder Powder

Careful control of the atomisation process for production of solder powders for LOCTITE GC 3W solder pastes ensures that the solder powder is produced to a quality level that exceeds J-STD-006, EN 29453 requirements for sphericity, size distribution, impurities and oxide levels.

Minimum order requirements may apply to certain alloys and powder sizes, for availability contact your local technical service helpdesk.

All solder powders are RoHS compliant.

Particle Size Distribution (PSD) (J-STD-005A)

Type 3 Powder

Type of officer	
Powder Description	T3
Powder Particle Size Distribution	25 to 45 μm
Henkel Former Description	AGS

Type 4 Powder

Type 41 older		
Powder Description	T4	
Powder Particle Size Distribution	20 to 38 μm	
Henkel Former Description	DAP	

Solder Alloy (J-STD 006)

LOCTITE Code	SAC305
Henkel Former Description	97SC
Melting Point (°C)	217

Solder Paste Typical Properties

Based on T3 powder

Basea on 15 powder	
Metal Content, %	89.5
Brookfield Viscosity @ 25°C, mPa.s	595,000
Spindle TF, Speed 5 rpm, 2 minutes	
Malcom Viscosity @ 25 °C, Pa.s	150
Speed 10 rpm	
Thixotropic Index (Ti)	0.45
$Ti = log (1.8/18 s^{-1})$	
Useful stencil life, hours	>24
IPC Slump , mm	
25°C, 15 minutes	
0.33 x 2.0 mm pads	0.2
0.63 x 2.0 mm pads	0.33
IPC Slump , mm	
182°C, 15 minutes	
0.33 x 2.0 mm pads	0.2
0.63 x 2.0 mm pads	0.33

Based on T4 powder

Basea on 14 powder	
Metal Content, %	89.5
Brookfield Viscosity @ 25 °C, Pa-s	784,000
Spindle TF, speed 5 rpm, after 2 minutes	
Malcom Viscosity @ 25 °C, Pa.s	180
Speed 10 rpm	
Thixotropic Index (Ti)	0.48
$Ti = log (1.8/18 s^{-1})$	
Useful stencil life, hours	>24
IPC Slump , mm	
25°C, 15 minutes	
0.33 x 2.0 mm pads	0.2
0.63 x 2.0 mm pads	0.33
IPC Slump , mm	
182°C, 15 minutes	
0.33 x 2.03 mm pads	0.2
0.63 x 2.03 mm pads	0.33

DIRECTIONS FOR USE

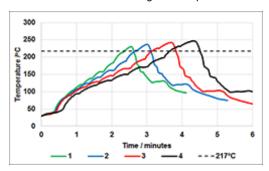
Printing:

- Printing at speeds up to 150 mm.s⁻¹ (6"/s) can be achieved using typical stencils and metal squeegees.
- Sufficient pressure should be applied to achieve a clean wipe of the stencil topside surface.
- Under laboratory conditions acceptable print quality on 0.5 mm ball devices and 0.4 mm QFP patterns has been achieved after printer down times of 4 hours without requiring a knead cycle.



Reflow:

- Reflow has been assessed using a typical convection reflow oven
- Optimal aerobic reflow can be achieved by ramping to a peak temperature of 225 to 250°C at 0.8 to 1.5°C/second and with a soak above the reflow temperature (217°C) for 20 to 50 seconds.
- Example profiles that have shown good performance- for reflow and subsequent cleaning- are presented below. Reflow soldering can also be carried out in a nitrogen atmosphere.



Cleaning:

- The post-soldering residues of LOCTITE GC 3W solder paste must be removed by cleaning.
- Cleaning can be performed using spray in air, spray under immersion or ultrasonic cleaning methods.
- The post-soldering residues are designed to be removed from assemblies in an aqueous cleaner without the use of rinse aids and/or saponifiers, typically using water at 40 to 60°C with deionized water for the final rinse.

RELIABILITY PROPERTIES

Flux Properties:

LOCTITE GC 3W contains a stable water-washable resin system and slow evaporating solvents

Test	Specification	Results
Flux Corrosion	J-STD004B (2.6.15C)	Pass
Copper Mirror	J-STD004B (2.3.32D)	Pass (cleaned)
Surface Insulation Resistance (SIR)	J-STD004B (2.6.3.7)	Pass (cleaned)
	J-STD004B (2.6.3.3)	Pass (cleaned)
Electromigration (ECM)	J-STD004B (2.6.14.1)	Pass
Flux Activity Classification	J-STD004B	ORM0

PACKAGING

LOCTITE GC 3W is available in 500 gram jars $\,$ and 600 grams Semco cartridge .

Storage:

Optimal storage: 0 to $25^{\circ}\text{C} \pm 1.5^{\circ}\text{C}$ (32 to $77^{\circ}\text{F} \pm 1.5^{\circ}\text{F}$)

Storage information may be indicated on the product container labelling. Material removed from containers may be contaminated during use. Do not return products to the original container. Henkel Corporation cannot assume responsibility for product that has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Shelf Life:

Provided LOCTITE GC 3W is stored tighly sealed in the original container at 0 to $25^{\circ}\text{C} \pm 1.5^{\circ}\text{C}$ (32 to $77^{\circ}\text{F} \pm 1.5^{\circ}\text{F}$), a minimum shelf life of 180 days can be expected.

DATA RANGES

The data contained herein may be reported as a typical value and/or a range. Values are based on actual test data and are verified on a periodic basis.

GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS).

Not for Product Specifications

The technical information contained herein is intended for reference only. Please contact Henkel Technologies Technical Service for assistance and recommendations on specifications for this product.

Conversions

 $(^{\circ}C \times 1.8) + 32 = ^{\circ}F$ kV/mm x 25.4 = V/mil mm / 25.4 = inches μ m / 25.4 = mil N x 0.225 = lb N/mm x 5.71 = lb/in N/mm² x 145 = psi MPa x 145 = psi MPa x 145 = lb·in N·m x 0.738 = lb·ft N·m x 0.738 = lb·ft N·m x 0.142 = oz·in mPa·s = cP

Disclaimer

Note:

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Reference 0.3

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600YSY 701-2758 707-1746 707-1748 707-1811 707-1813 707-1831 707-1840 707-1850 707-1852 13-217-3-01 P10695 SN63WRAP3.022-1-LB 24-6040-0007 DAC-061 701-2089 707-0285 707-0366 707-0441-26 707-1774 707-1810 24-6337-9727 601Y 24-9574-7619
24-4060-2437 14-6040-0125 04-0595-0000 5901003 631960 SW02-10 S2626-O-T 8055 5760140 TRWR-204 1152 EC2002M-1 WPT17
WS6016 760-2028 8001115 8001073 8001495 41-096-0202N 41-096-0203N ART.AGT-030 389289 54068 ECO 1 (SNCU1) FLUX B2.1
0,8 MM 250G ECO3 (SNCU3) FLUX B2.1 0,8 MM 250 G. ECO3 (SNCU3) FLUX B2.1 0,8 MM 1000 G.